PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Nobuaki KATAOKA	11/01/2020
Takahiro TOKO	11/18/2020
Takafumi YAMAGUCHI	11/24/2020
Yukinobu EZAKI	11/22/2020

RECEIVING PARTY DATA

Name:	Jtekt Corporation	
Street Address:	5-8, Minamisemba 3-Chome, Chuo-ku	
City:	Osaka-shi, Osaka	
State/Country:	Japan	
Postal Code:	542-8502	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17007017

CORRESPONDENCE DATA

Fax Number: (703)836-2787

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided: if that is unsuccessful, it will be sent via US Mail.

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 703-836-6400
Email: email@oliff.com
Correspondent Name: JOHN A. RADI
Address Line 1: OLIFF PLC

Address Line 2: P.O. BOX 320850

Address Line 4: ALEXANDRIA, VIRGINIA 22320-4850

ATTORNEY DOCKET NUMBER:	193437	
NAME OF SUBMITTER:	MONIQUE L. GRIFFITH	
SIGNATURE:	/Monique L. Griffith/	
DATE SIGNED: 01/27/2021		
This document serves as an Oath/Declaration (37 CFR 1.63).		

Total Attachments: 2

PATENT REEL: 055044 FRAME: 0927

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> PATENT REEL: 055044 FRAME: 0928

- Attorney Docket No.: Client Ref.: P190057US00

DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT FOR SINGLE ASSIGNEE

Title of Invention	STEERING CONTROL DEVICE			
As the below named inventor, I hereby declare that:				
This declaration is directed to: The attached application, or				
,	United States application or PCT international application number 17/007,017 filed on August 31, 2020			
The above-ide	entified application was made or authorized to be made by me.			
I believe that	I am the original inventor or an original joint inventor of a claimed invention in the application.			
I have review	ed and understand the contents of the application for which this assignment with declaration is being submitted.			
I am aware of	the duty to disclose to the Office all information known to me to be material to patentability as defined in 37 CFR 1.56.			
I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.				
WHEREAS, JTEKT CORPORATION , with offices at 5-8, Minamisemba 3-Chome, Chuo-ku, Osaka-shi, Osaka 542-8502 Japan (hereinafter referred to as ASSIGNEE), is desirous of acquiring all interest in, to and under said invention, said application disclosing the				
invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;				
NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I by these presents do hereby assign, sell and transfer unto said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue said United States Letters Patent to said ASSIGNEE, as the assignce of the whole right, title and interest thereto;				
And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;				
And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any renewal or reissues of any Letters Patent which may be granted for my aforesaid invention, as said ASSIGNEE thereof shall hereafter require and prepare at its own expense;				
And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;				
And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.				

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NAME OF SOLE OR FIRST INVENTOR:				
Given Name				
(first and middle [if any]) Nobuaki	Family Name or Surname KATAOKA			
Inventor's signature Nobuaki Kataoku	Date November 1st, 2020			
Residence: Okazaki-shi, Aichi, Japan				
c/o JTEKT CORPORATION Mailing Address: 5-8, Minamisemba 3-Chome, Chuo-ku, Osaka-sl	ni, Osaka 542-8502 Japan			
NAME OF SECOND INVENTOR:				
Given Name (first and middle [if any]) Takahiro Family Name or Surname TOKO				
Inventor's signature Takahiro Toko	Date November 18, 2020			
Residence: Takahama-shi, Aichi, Japan				
c/o JTEKT CORPORATION Mailing Address: 5-8, Minamisemba 3-Chome, Chuo-ku, Osaka-shi, Osaka 542-8502 Japan				
NAME OF THIRD INVENTOR:				
Given Name . (first and middle [if any]) Takafumi Family Name or Surname YAMAGUCHI				
Inventor's signature Takafumi Yamaguch				
Residence: Kuwana-shi, Mie, Japan				
c/o JTEKT CORPORATION Mailing Address: 5-8, Minamisemba 3-Chome, Chuo-ku, Osaka-shi, Osaka 542-8502 Japan				
NAME OF FOURTH INVENTOR:				
Given Name (first and middle [if any]) Yukinobu	Family Name or Surname EZAKI			
Inventor's signature Yukinobu Ezaki	Date perember 12, 2020			
Residence: Kasugai-shi, Aichi, Japan				
c/o TOYOTA JIDOSHA KABUSHIKI KAISHA				
Mailing Address: 1, Toyota-cho, Toyota-shi, Aichi-ken 471-8571 Japan				

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RECORDED: 01/27/2021